

portion of the conductive paint. In some examples, operation 514 may occur before the mounting operation 512.

[0056] One or more connected nodes of the processing unit may be programmed at operation 516. Programming of a processing unit is described above in previous examples. In some examples, flow may proceed to operation 518 where a storage device is connected with the processing unit. Examples of storage devices, processing units, connection, and interaction with other electrical components have been previously described.

[0057] In some examples where an interactive displayable device comprises additional electrical components, a speaker and an amplifier may be mounted to an exemplary structure in operation 520. Examples of speakers, amplifiers, mounting, and interaction with other electrical components (including a processing unit) have been previously described. Flow may proceed to operation 522 where electrical components are connected. In examples, one or more of a processing unit, amplifier and speaker may be connected. Additionally, one or more power sources may be connected to one or more electrical components as a power source to provide supply of power to an interactive displayable device. In some examples, operation 522 may comprise affixing an independent power source to the interactive displayable device that may provide power to the displayable device without requiring connection to another power source such as an outlet or processing device.

[0058] Flow may proceed to operation 524, where testing and/or modification may occur of the exemplary interactive displayable device. In examples, operation 524 may comprise testing output of content based on touch interaction. In some examples, operation 524 may further comprise modifying the structure of an exemplary interactive displayable device based on testing, for example. In other examples, operation 524 may comprise adding to a framework of an exemplary structure, for example by adding one or more additional surfaces for interactivity. As an example, another surface may be added, for example that may obscure view of electrical components. Similar processing operations as described above may be applied to transform the one or more additional surfaces into interactive surfaces.

[0059] In examples, the configuration of an exemplary interactive displayable device provides direct mapping to specific content output. That is, the environment in which an interactive displayable device operates is thought-out and programmatically configured to maximize output and experience for an end user. The exemplary structure is configured such that electrical components are housed by structure and are self-contained within the structure. This configuration provide benefits over what is known as the configuration of the structure around the electrical components may create a unique environment that enables output to be channeled in a controlled manner, for example. As another benefit, exemplary devices disclosed herein may create an effect of reverberation of sound output that is not re-creatable by other known products. Other examples may also comprise adding of additional components and/or objects to further maximize, amplify or otherwise manipulate output of content such as audio, light, video, etc.

[0060] This disclosure described some aspects of the present technology with reference to the accompanying drawings, in which only some of the possible embodiments were shown. Other aspects may, however, be embodied in many different forms and should not be construed as limited to the

embodiments set forth herein. Rather, these aspects were provided so that this disclosure was thorough and complete and fully conveyed the scope of the possible embodiments to those skilled in the art.

[0061] Although specific aspects were described herein, the scope of the technology is not limited to those specific embodiments. One skilled in the art will recognize other embodiments or improvements that are within the scope and spirit of the present technology. Therefore, the specific structure, acts, or media are disclosed only as illustrative embodiments. The scope of the technology is defined by the following claims and any equivalents therein.

What is claimed is:

1. A method comprising:
 - applying conductive paint to a structure that comprises one or more apertures, wherein the applying further comprises applying the conductive paint to at least one surface of the structure and within the one or more apertures;
 - mounting a processing unit to a portion of the structure;
 - connecting at least one node of the processing unit with the applied conductive paint; and
 - programming the node of the processing unit.
2. The method of claim 1, wherein the programming comprises setting the node to output content that is pre-programmed into the processing unit.
3. The method of claim 1, wherein the programming comprises connecting the processing unit to a processing device, and executing an application to program/re-program the node to output content.
4. The method of claim 1, wherein the programming comprises connecting the processing unit to a processing device, and executing an application to program the node to read content from a storage device.
5. The method of claim 4, further comprising connecting the storage device with the processing unit.
6. The method of claim 1, further comprising connecting the processing unit to a power source.
7. The method of claim 1, further comprising drilling the one or more apertures into the structure.
8. The method of claim 1, further comprising mounting a speaker and an amplifier to the structure, connecting the processing unit with the amplifier, and connecting the amplifier with the speaker.
9. The method of claim 8, further comprising connecting at least one of the processing unit, the amplifier and the speaker to a power source.
10. The method of claim 8, further comprising drilling a second set of apertures into the surface of the structure to enable passing of sound emittable from the speaker.
11. The method of claim 1, further comprising applying a layer of primer to the structure over the conductive paint.
12. The method of claim 11, further comprising applying, over the applied layer of primer, at least one from a group consisting of: at least one layer of paint and an object.
13. The method of claim 12, further comprising providing a layer of sealant over the layer of paint or the object.
14. The method of claim 1, wherein the connecting of the node with the conductive paint further comprises connecting at least one wire to the node of the processing unit and placing an end of the wire in contact with the conductive paint.